

Board Level Cooling – Surface Mount 5733



BOARD LEVEL COOLING – Surface Mount 5733

Surface Mount 5733 is a series of surface mount board level heat sinks designed to cool D2 Pak and TO-263 devices. Representative Image Only.

ORDERING INFORMATION

Part Number	Device Type
573300D00000G	D2 Pak, TO-263
573300D00010G	D2 Pak, TO-263



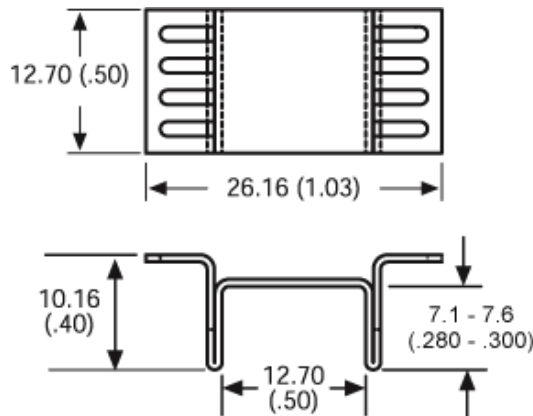
HEAT SINK DETAILS

Property	Details
Material	Aluminum
Finish	Tin Plated
Device Attachment Options	-
Thermal Interface Material	-

Property	Details
Heat Sink Width (mm)	26.16
Heat Sink Length (mm)	12.70
Heat Sink Height (mm)	10.16
Heat Sink Mounting Direction	Horizontal

MECHANICAL & PERFORMANCE

Drawing dimensions are shown in mm, (in)



Note: The thickness of the drain pad is variable depending on the amount of heat generated by the SMT device, design, limitations and process. This is the exposed printed circuit.

